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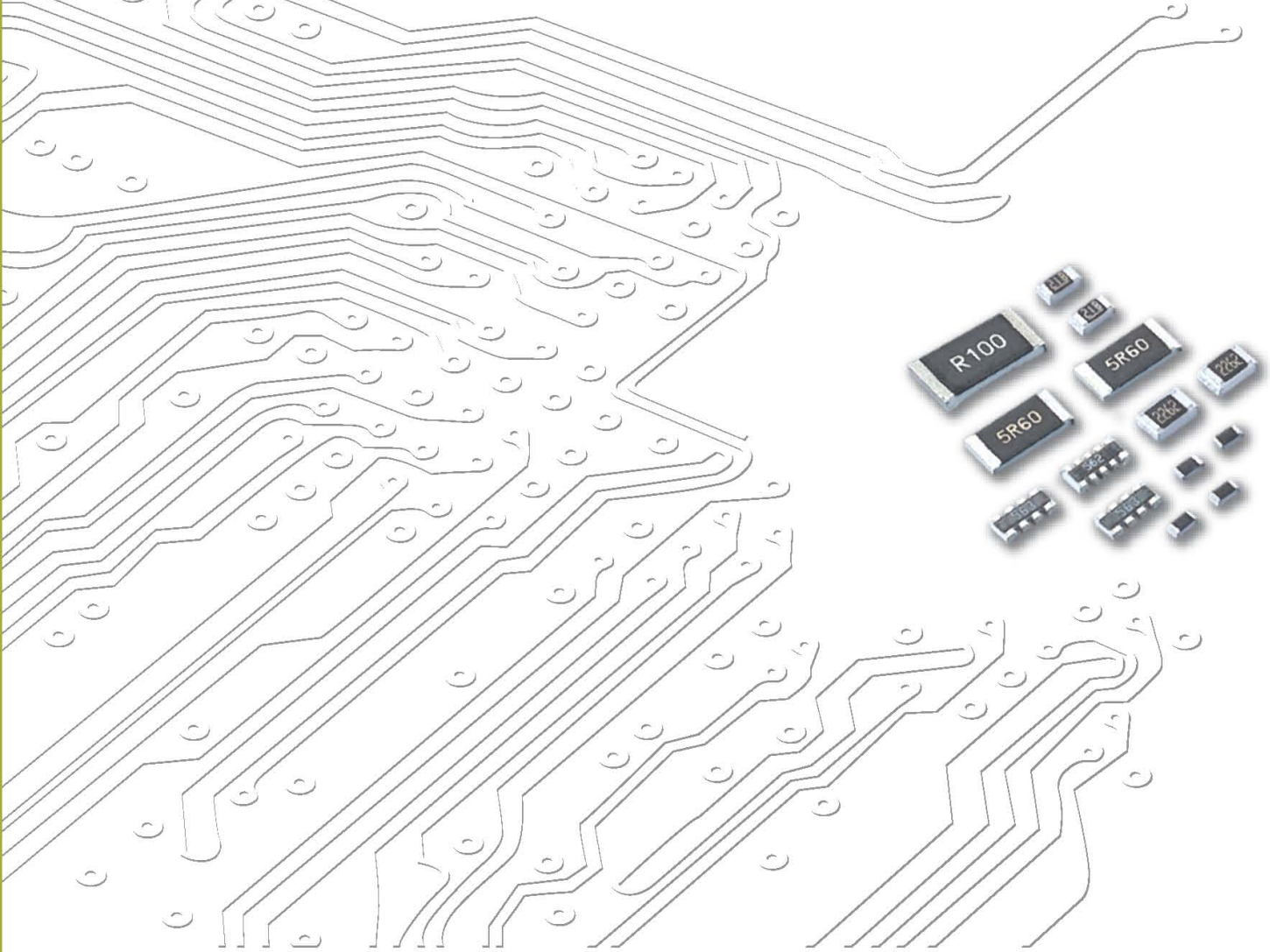
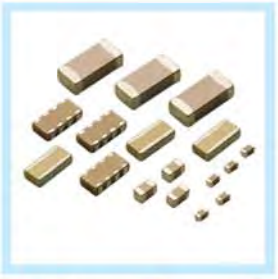
2013 Chip Resistors

Product catalog



華新科技股份有限公司
Walsin Technology Corporation

Product Portfolio

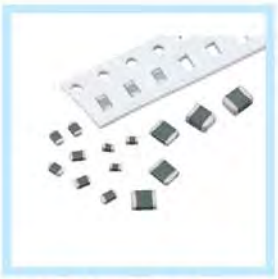


Multilayer Ceramic Capacitors (MLCC)

Chip-Resistor

Disc Capacitors

RF Device and High Frequency Inductors



Varistors and SMD-Varistors

IEC-63 Nominal Resistance / Capacitance

E1	100																							
E3	100							220										470						
E6	100				150				220				330				470				680			
E12	100		120		150		180		220		270		330		390		470		560		680		820	
E24	100	110	120	130	150	160	180	200	220	240	270	300	330	360	390	430	470	510	560	620	680	750	820	910
E96	100	102	121	124	147	150	178	182	215	221	261	267	316	324	383	392	464	475	562	576	681	698	825	845
	105	107	127	130	154	158	187	191	226	232	274	280	332	340	402	412	487	499	590	604	715	732	866	887
	110	113	133	137	162	165	196	200	237	243	287	294	348	357	422	432	511	523	619	634	750	768	909	931
	115	118	140	143	169	174	205	210	249	255	301	309	365	374	442	453	536	549	649	665	787	806	953	976

E6: $\sqrt[6]{10} \fallingdotseq 1.46$ E12: $\sqrt[12]{10} \fallingdotseq 1.21$
E1 series resistance: 1Ω, 10Ω, 100Ω, 1000Ω, 10000Ω, 100000Ω

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*The specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
*This catalog has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specification before ordering.

HOW TO ORDER

WR	12	X	1000	F	T	L
Type code	**Size code**	**Functional code**	**Resistance**	**Tolerance**	**Packaging code**	**Termination code**
WR : General 1~10MR MR: Automotive SR: Anti-Sulfuration ZR: Non magnetic	25 : 2512 (6432) 20 : 2010 (5025) 18 : 1218 (3248) 12 : 1206 (3216) 10 : 1210 (3225) 08 : 0805 (2012) 06 : 0603 (1608) 04 : 0402 (1005) 02 : 0201 (0603) 01 : 01005 (0402)	X : 5% for 1 ~ 10MΩ 1% for 10 ~ 1MΩ W : 1% for <10Ω and >1MΩ Y : 5% for 1 ~ 10MΩ (Low profile) 1% for 10 ~ 1MΩ (Low profile) Z : 1% for <10Ω or >1MΩ (Low profile) F: TC100 1-10ohm, 1% E: TC100, 100-1Mohm, 5%	E24(J tol.) : 2 significant digits followed by No. of zeros and a blank e.g. : 3ohm = 3R0_ 10ohm = 100_ 220ohm = 221_ 56Kohm = 563_ ("_" means blank) E24+E96 (F tol.) : 3 significant digits followed by No. of zeros e.g. : 3Ω = 3R00 10Ω = 10R0 220Ω = 2200 56KΩ = 5602	F : ± 1% J : ± 5% P : Jumper H : +5% ~ 0%	P : 4" reel taping T : 7" reel taping A : 7" reel taping 15Kpcs D : 7" reel taping 20Kpcs E : 7" up side down taping V : 7" reel taping 1Kpcs Q : 10" reel taping G : 13" reel taping H : 0402-50K/13" reel R : 0603 2mm pitch taping B : Bulk K : Bulkcase C : Bulk after measuring	L = Sn base (Lead free) R = Pb ≦100ppm (total) W = Wide term. A = Anti-leaching

WW	12	M	R002	F	T	L
Type code	**Size code**	**Functional code**	**Resistance**	**Tolerance**	**Packaging code**	**Termination code**
WW: R < 1Ω MW: R < 1Ω, AUTO SW: R < 1Ω, Anti-Sulfu	25 : 2512 (6432) 20 : 2010 (5025) 18 : 1218 (3248) 12 : 1206 (3216) 10 : 1210 (3225) 08 : 0805 (2012) 06 : 0603 (1608) 04 : 0402 (1005)	X : Thick film low ohm W : Thick film low ohm low TCR Q : Metal low ohm M : Metal low ohm R : Metal low ohm high power N : Metal low ohm high power P : Thick film low TCR high Power 2512 = 2W 2010 = 1W 1210 = 0.5W 1206 = 0.5W C : Thick film Power low ohm up side down	R followed by 3 significant digits e.g. : 0.1Ω = R100 0.033Ω = R033 0.56Ω = R560	F : ± 1% G : ± 2% J : ± 5%	P : 4" reel taping T : 7" reel taping Q : 10" reel taping G : 13" reel taping R : 0603 2mm pitch taping B : Bulk K : Bulkcase	L = Sn base (Lead free) G = Au base S = Ag base

WF	12	T	1001	B	T	L
Type code	**Size code**	**Functional code**	**Resistance**	**Tolerance**	**Packaging code**	**Termination code**
WF : Special function MF : Special function AUTO SF : Special function Anti-S WK: Special function made in KM	25 : 2512 (6432) 20 : 2010 (5025) 18 : 1218 (3248) 12 : 1206 (3216) 10 : 1210 (3225) 08 : 0805 (2012) 06 : 0603 (1608) 04 : 0402 (1005)	G : High ohm (>10MΩ) H : Thick film, High Precision <1% K : Thick film, TCR50ppm M : Trimmable P : High Power S : Surge T : Thin film, TCR50ppm U : Thin film, TCR25ppm Q : Thin film, TCR50ppm, power R : Thin film, TCR25ppm, power F : Thin film TCR15ppm W : Thin film TCR10ppm Z : Thin film TCR 5ppm V : High voltage X : Special resistance Y : E24/E96 resistance with special termination	E24(J tol.) : 2 significant digits followed by No. of zeros and a blank e.g. : 3ohm = 3R0_ 10ohm = 100_ 220ohm = 221_ 56Kohm = 563_ ("_" means blank) E24+E96 (F tol.) : 3 significant digits followed by No. of zeros e.g. : 3Ω = 3R00 10Ω = 10R0 220Ω = 2200 56KΩ = 5602	A : ± 0.05% B : ± 0.1% C : ± 0.25% D : ± 0.5% F : ± 1% G : ± 2% J : ± 5% K : ± 10% L : ± 15% M : ± 20% P : Jumper X : 0/-30% Y : 0/-20% Z : 0/-10% Q : -0.8%~-1.0% Y : +0.8%~+1.0% Y : -10% ~ -9%	P : 4" reel taping T : 7" reel taping Q : 10" reel taping G : 13" reel taping R : 0603 2mm pitch taping B : Bulk K : Bulkcase D : 7" reel taping 20Kpcs V : 7" reel taping 1Kpcs A : 7" reel taping 15Kpcs	L = Sn base (Lead free) G = Au base S = Ag base C = Cu base D = Cu base + Low profile

WA	04	X	103_	J	T	L
Type code	**Size code**	**Functional code**	**Resistance**	**Tolerance**	**Packaging code**	**Termination code**
WA: Array MA: Convex Array Auto SA: Concave Array Anti-Sulfu	06 : 0603 (1608) 04 : 0402 (1005) 02 : 0201 (0603)	X : *4, convex Y : *2, convex W : *8, convex T : *4, concave U : *2, concave P : *3, convex (Attenuator) A: *4, FLAT B: *2, FLAT	E24(J tol.) : 2 significant digits followed by No. of zeros and a blank e.g. : 3ohm = 3R0_ 10ohm = 100_ 220ohm = 221_ 56Kohm = 563_ ("_" means blank) E24+E96 (F tol.) : 3 significant digits followed by No. of zeros e.g. : 3Ω = 3R00 10Ω = 10R0 220Ω = 2200 56KΩ = 5602	F : ± 1% J : ± 5% P : Jumper	T : 7" reel taping A : 7" reel taping 15Kpcs Q : 10" reel taping G : 13" reel taping B : Bulk K : Bulkcase	L = Sn base (Lead free)

WT	04	X	103_	J	T	L
Type code	**Size code**	**Functional code**	**Resistance**	**Tolerance**	**Packaging code**	**Termination code**
T : Network Resistors	04 : total package size 1206 (3216)	X : *8, convex	E24(J tol.) : 2 significant digits followed by No. of zeros and a blank e.g. : 3ohm = 3R0_ 10ohm = 100_ 220ohm = 221_ 56Kohm = 563_ ("_" means blank)	J : ± 5% P : Jumper	T : 7" reel taping B : Bulk	L = Sn base (Lead free)

Remark :

1. Detail product part number, functional code, tolerance combination,…... please refer to specific data sheet.
2. Example : ("_" means a blank)
   Chip-R 0805 size, 4.3ohm, 5%, Normal type, SnPb termination, 5000pcs taped in reel : WR08X4R3_JTL
3. 1218 standard packing q'ty is 3Kpcs in 10" reel and packing code is T code

Chip Resistor Selection Guide

General Purpose Chip-R

Series	Size	Rated Power	TCR (ppm/℃)*	Tolerance	Resistance
WR25X	2512 (6432)	1W	±100	±1%	1 ~ 10MΩ
			±200	±5%	
WR18X	1218 (3248)	1W	±100	±1%	
			±200	±5%	
WR20X	2010 (5025)	1/2W	±100	±1%	
			±200	±5%	
WR10X	1210 (3225)	1/3W	±100	±1%	
			±200	±5%	
WR12X	1206 (3216)	1/4W	±100	±1%	
				±5%	
WR08X	0805 (2012)	1/8W	±100	±1%	
				±5%	
WR06X	0603 (1608)	1/10W	±100	±1%	
				±5%	
WR04X	0402 (1005)	1/16W	±100	±1%	
				±5%	
WR02X	0201 (0603)	1/20W	±200	±1%	
			±200	±5%	
WR01X	01005 (0402)	1/32W	±200	±1%	4.7 ~ 1MΩ
			±200	±5%	

Remark: 1. Detailed resistance vs. TCR and ordering code please refer to specific specifications.
2. Jumper resistor is not designed for fusing applications, designers shall apply dedicate fusible resistor or standard fuse in application circuits.
3. WRxxW defines for ±1% < 10ohm or > 1Mohm.

Thick Film Low Ohm Chip-R

Series	Size	Rated Power	TCR (ppm/℃)	Tolerance	Resistance
WW25X	2512 (6432)	1W	≦1500**	±1%	0.020Ω ~ 0.976Ω
				±5%	0.015Ω ~ 0.976Ω
WW18X	1218 (3248)	1W		±1%	0.020Ω ~ 0.976Ω
				±5%	0.015Ω ~ 0.976Ω
WW20X	2010 (5025)	1/2W		±1%	0.020Ω ~ 0.976Ω
				±5%	0.015Ω ~ 0.976Ω
WW10X	1210 (3225)	1/3W	≦200	±1%	0.020Ω ~ 0.976Ω
				±5%	0.020Ω ~ 0.976Ω
WW12X	1206 (3216)	1/4W	≦1500**	±1%	0.020Ω ~ 0.976Ω
				±5%	0.020Ω ~ 0.976Ω
WW08X	0805 (2012)	1/8W	≦1500**	±1%	0.020Ω ~ 0.976Ω
				±5%	0.020Ω ~ 0.976Ω
WW06X	0603 (1608)	1/10W	≦500**	±1%	0.100Ω ~ 0.976Ω
				±5%	0.100Ω ~ 0.976Ω
WW04X	0402 (1005)	1/16W	≦600**	±1%	0.100Ω ~ 0.976Ω
				±5%	0.100Ω ~ 0.976Ω

Remark: 1. Detailed resistance vs. TCR and ordering code please refer to specific specifications.
2. Resistance value will be changed by soldering condition and design of soldering pad, please design products in consideration of this change.

Thick Film Power Low Ohm Chip-R

Series	Size	Rated Power	TCR (ppm/℃)	Tolerance	Resistance
WW25P	2512 (6432)	2W	< 0.1Ω: 150ppm ≧0.1Ω: 100ppm	±1%, ±5%	0.047Ω ~ 0.976Ω
WW20P	2010 (5025)	1W	< 0.1Ω: 150ppm ≧0.1Ω: 100ppm	±1%, ±5%	0.047Ω ~ 0.976Ω
WW10P	1210 (3225)	1/2W	< 0.1Ω: 500ppm ≧0.1Ω: 200ppm	±1%, ±5%	0.020Ω ~ 0.976Ω
WW12P	1206 (3216)	1/2W	< 0.1Ω: 200ppm ≧0.1Ω: 100ppm	±1%, ±5%	0.047Ω ~ 0.976Ω
WW08P	0805 (2012)	1/3W	< 0.1Ω: 200ppm ≧0.1Ω: 150ppm	±1%, ±5%	0.047Ω ~ 0.976Ω
WW06P	0603 (1608)	1/4W	< 0.1Ω: 250ppm ≧0.1Ω: 200ppm	±1%, ±5%	0.047Ω ~ 0.976Ω
WW04P	0402 (1005)	1/8W	< 0.1Ω: 300ppm ≧0.1Ω: 200ppm	±1%, ±5%	0.100Ω ~ 0.976Ω
WW12C	1206 (3216)	1/2W	< 0.02Ω: 150ppm ≧0.02Ω: 100ppm	±1%, ±5%	0.015Ω ~ 0.100Ω
WW08C	0805 (2012)	1/3W	< 0.03Ω: 200ppm ≧0.03Ω: 100ppm	±1%, ±5%	0.025Ω ~ 0.100Ω
WW06C	0603 (1608)	1/4W	< 0.051Ω: 0~+250ppm ≧0.051Ω: ±150ppm	±1%, ±5%	0.020Ω ~ 0.100Ω
WW04C	0402 (1005)	1/8W	< 0.051Ω: 0~+350ppm ≧0.051Ω: ±150ppm	±1%, ±5%	0.025Ω ~ 0.100Ω
WW02C	0201 (0603)	1/10W	< 0.033Ω: 500ppm < 0.051Ω: 300ppm ≧0.051Ω: 100ppm	±1%, ±5%	0.020Ω ~ 0.100Ω

Metal Low Ohm Sensing Type Chip-R

Series	Size	Rated Power	TCR (ppm/℃)*	Tolerance	Resistance
WW59M	5931 (15079)	5W	±100	±1%, ±5%	2, 3, 5mΩ
WW25N	2512 (6432)	2W	±100	±1%, ±5%	3, 5, 10, 15, 20, 25mΩ
WW25R		2W	±100	±1%, ±5%	1, 2, 3, 4, 5, 6, 7, 10mΩ
WW25M		1W	±100	±1%, ±5%	3, 5, 10, 15, 20, 25, 50mΩ
WW25Q		1W	±100	±1%, ±5%	1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15mΩ
WW20N	2010 (5025)	1W	±75	±1%, ±5%	5, 10, 15, 20mΩ
WW12N	1206 (3216)	1W	±70	±1%, ±5%	5, 10, 15, 20, 25mΩ
WW12R		1W	±100	±1%, ±5%	1 ~ 15mΩ
WW12D		1W	±100	±1%, ±5%	20, 25, 30, 40, 50mΩ
WW08R	0805 (2012)	1/2W	±100	±1%, ±5%	4, 5, 10mΩ
WW08D	0805 (2012)	1/2W	±100	±1%, ±5%	20, 25, 30, 40, 50mΩ
WW06R	0603 (1608)	1/3W	±100	±1%, ±5%	5, 10, 15mΩ

Remark: 1. Detailed resistance vs. TCR and ordering code please refer to specific specifications.
2. Resistance value will be changed by soldering condition and design of soldering pad, please design products in consideration of this change.

Chip Resistor Array

Series	Size	Rated Power	TCR (ppm/℃)	Termination	Tolerance	Resistance
WA06X	1206 (0603x4)	1/10W	±200	Convex	±1%, ±5%	10 ~ 1MΩ
WA06T	1206 (0603x4)	1/10W	±200	Concave	±1%, ±5%	
WA06Y	0606 (0603x2)	1/10W	±200	Convex	±1%, ±5%	
WA04X	0804 (0402x4)	1/16W	±200	Convex	±1%, ±5%	
WA04T	0804 (0402x4)	1/16W	±300	Concave	±1%, ±5%	
WA04Y	0404 (0402x2)	1/16W	±200	Convex	±1%, ±5%	
WA04U	0404 (0402x2)	1/16W	±300	Concave	±1%, ±5%	
WA06W	1606 (0402x8)	1/16W	±200	Convex	±1%, ±5%	10 ~ 100KΩ
WA02Y	0806 (0201x2)	1/32W	±300	Convex	±1%, ±5%	10 ~ 1MΩ

Remark: 1. Detailed resistance vs. TCR and ordering code please refer to specific specifications.
2. Resistance value will be changed by soldering condition and design of soldering pad, please design products in consideration of this change.

Chip Attenuator

Series	Size	Type	Termination	Tolerance	Attenuation	Impedance
WA04P	0404 (0402x2)	4P3R, Π type	Convex	±0.1dB ~ 2.5dB	0, 0.5dB ~ 20dB	50Ω

Chip Resistor Network

Series	Size	Rated Power	TCR (ppm/℃)	Termination	Tolerance	Resistance
WT04X	1206 (10P8R)	1/16W	±200	Convex	±5%	10 ~ 100KΩ

High Power Chip-R

Series	Size	Rated Power	TCR (ppm/℃)	Tolerance	Resistance
WF25P	2512 (6432)	2W	±100	±1%, ±5%	Jumper; 1 ~ 1MΩ
WF20P	2010 (5025)	1W	±100		
WF10P	1210 (3225)	1/2W	±100		
WF12P	1206 (3216)	1/2W	±100		
WF08P	0805 (2012)	1/4W	±100		
WF06P	0603 (1608)	1/8W	±100		
WF04P	0402 (1005)	1/8W	±100		

Automotive Chip-R

Series	Size	Rated Power	TCR(ppm/℃)	Tolerance	Resistance
MR12	1206 (3216)	1/4W	±200	±1%, ±5%	1~ 10MΩ
MR08	0805 (2012)	1/8W	±200		1~ 10MΩ
MR06	0603 (1608)	1/10W	±200		1~ 10MΩ
MR04	0402 (1005)	1/16W	±200		1~ 10MΩ

Anti-Sulfuration Chip-R

Series	Size	Rated Power	TCR(ppm/℃)	Tolerance	Resistance
SR12	1206 (3216)	1/4W	≦200	±1%, ±5%	1~ 10MΩ
SR08	0805 (2012)	1/8W	≦200	±1%, ±5%	1~ 10MΩ
SR06	0603 (1608)	1/10W	≦200	±1%, ±5%	1~ 10MΩ
SR04	0402 (1005)	1/16W	≦200	±1%, ±5%	1~ 10MΩ

Surge Chip-R

Series	Size	Rated Power	TCR(ppm/℃)	Tolerance	Resistance
WK25S	2512 (6432)	1W	≦200	±5%, ±10%	0.27 ~ 22MΩ
WK20S	2010 (5025)	3/4W	≦200	±5%, ±10%	0.27 ~ 22MΩ
WK10S	1210 (3225)	1/2W	≦200	±5%, ±10%	0.27 ~ 22MΩ
WK12S	1206 (3216)	1/4W	≦200	±5%, ±10%	0.27 ~ 22MΩ
WK08S	0805 (2012)	1/8W	≦200	±5%, ±10%	0.27 ~ 22MΩ

High Voltage Chip-R

Series	Size	Rated Power	TCR(ppm/℃)	Voltage (V)	Tolerance	Resistance
WK25Z	2512 (6432)	1W	≦200	2000	±5%, ±10%, ±20%	4.7M ~ 16MΩ
WK20Z	2010 (5025)	1/2W	≦200	1500	±5%, ±10%, ±20%	1M ~ 16MΩ
WK25V	2512 (6432)	1W	≦200	800	±1%, ±5%	47~ 51MΩ
WK20V	2010 (5025)	1/2W	≦200	500	±1%, ±5%	47~ 51MΩ
WK12V	1206 (3216)	1/4W	≦200	500	±1%, ±5%	47~ 51MΩ
WK08V	0805 (2012)	1/8W	≦200	400	±1%, ±5%	47~ 51MΩ
WK06V	0603 (1608)	1/10W	≦200	200	±1%, ±5%	47~ 10MΩ

Trimmable Chip-R

Series	Size	Rated Power	TCR(ppm/℃)	Tolerance	Resistance
WK25M	2512 (6432)	1W	≦200	0/-20%, 0/-30%	1 ~ 4.7MΩ
WK20M	2010 (5025)	1/2W	≦200	0/-20%, 0/-30%	1 ~ 4.7MΩ
WK10M	1210 (3225)	1/4W	≦200	0/-20%, 0/-30%	1 ~ 4.7MΩ
WK12M	1206 (3216)	1/8W	≦200	0/-20%, 0/-30%	1 ~ 4.7MΩ
WK08M	0805 (2012)	1/10W	≦200	0/-20%, 0/-30%	1 ~ 4.7MΩ
WK06M	0603 (1608)	1/16W	≦100	0/-20%, 0/-30%	10~ 4.7MΩ

Total lead free Chip-R (Pb < 100ppm)

Series	Size	Rated Power	TCR(ppm/℃)	Tolerance	Resistance
WR12X_R	1206 (3216)	1/4W	≦200	±1%, ±5%	1~ 10MΩ
WR08X_R	0805 (2012)	1/8W	≦200	±1%, ±5%	1~ 10MΩ
WR06X_R	0603 (1608)	1/10W	≦200	±1%, ±5%	1~ 10MΩ
WR04X_R	0402 (1005)	1/16W	≦200	±1%, ±5%	1~ 10MΩ
WR02X_R	0201 (0603)	1/20W	≦200	±1%, ±5%	1~ 10MΩ
WA04X_R	0402X4	1/16W	≦200	±1%, ±5%	10 ~ 1MΩ
WA04Y_R	0402X2	1/16W	≦200	±1%, ±5%	10 ~ 1MΩ

High Precision Chip-R

Series	Size	Rated Power	TCR(ppm/℃)	Tolerance	Resistance
WF10H	1210 (3225)	1/3W	≦100	±0.1%, ±0.5%	10 ~ 1MΩ
WF12H	1206 (3216)	1/4W	≦100	±0.1%, ±0.5%	10 ~ 1MΩ
WF08H	0805 (2012)	1/8W	≦100	±0.1%, ±0.5%	10 ~ 1MΩ
WF06H	0603 (1608)	1/10W	≦100	±0.1%, ±0.5%	10 ~ 1MΩ
WF04H	0402 (1005)	1/16W	≦100	±0.1%, ±0.5%	10 ~ 1MΩ
WF25T	2512 (6432)	3/4W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF25Q	2512 (6432)	1W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF20T	2010 (5025)	1/2W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF20Q	2010 (5025)	3/4W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF10T	1210 (3225)	1/4W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1MΩ
WF10Q	1210 (3225)	2/5W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1MΩ
WF12T	1206 (3216)	1/8W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF12Q	1206 (3216)	1/4W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF08T	0805 (2012)	1/10W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF08Q	0805 (2012)	1/8W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF06T	0603 (1608)	1/16W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 680KΩ
WF06Q	0603 (1608)	1/10W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 680KΩ
WF04T	0402 (1005)	1/16W	≦50	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 100KΩ
WF25U	2512 (6432)	3/4W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF25R	2512 (6432)	1W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF20U	2010 (5025)	1/2W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF20R	2010 (5025)	3/4W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1.5MΩ
WF10U	1210 (3225)	1/4W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1MΩ
WF10R	1210 (3225)	2/5W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 1MΩ
WF12U	1206 (3216)	1/8W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF12R	1206 (3216)	1/4W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF08U	0805 (2012)	1/10W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF08R	0805 (2012)	1/8W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 1MΩ
WF06U	0603 (1608)	1/16W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 680KΩ
WF06R	0603 (1608)	1/10W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	4.7 ~ 680KΩ
WF04U	0402 (1005)	1/16W	≦25	±0.05%, ±0.10%,±0.25%, ±0.50%, ±1.0%	10 ~ 100KΩ
WF12F	1206 (3216)	1/8W	≦15	±0.05%, ±0.10%,±0.25%	100 ~ 200KΩ
WF08F	0805 (2012)	1/8W	≦15	±0.05%, ±0.10%,±0.25%	100 ~ 200KΩ
WF06F	0603 (1608)	1/10W	≦15	±0.05%, ±0.10%,±0.25%	100 ~ 100KΩ
WF04F	0402 (1005)	1/16W	≦15	±0.05%, ±0.10%,±0.25%	100 ~ 20KΩ
WF12W	1206 (3216)	1/8W	≦10	±0.05%, ±0.10%,±0.25%	25 ~ 300KΩ
WF08W	0805 (2012)	1/8W	≦10	±0.05%, ±0.10%,±0.25%	25 ~ 200KΩ
WF06W	0603 (1608)	1/10W	≦10	±0.05%, ±0.10%,±0.25%	25 ~ 100KΩ
WF04W	0402 (1005)	1/16W	≦10	±0.05%, ±0.10%,±0.25%	25 ~ 20KΩ
WF12Z	1206 (3216)	1/8W	≦5	±0.05%, ±0.10%,±0.25%	25 ~ 120KΩ
WF08Z	0805 (2012)	1/8W	≦5	±0.05%, ±0.10%,±0.25%	25 ~ 80KΩ
WF06Z	0603 (1608)	1/10W	≦5	±0.05%, ±0.10%,±0.25%	25 ~ 40KΩ
WF04Z	0402 (1005)	1/16W	≦5	±0.05%, ±0.10%,±0.25%	25 ~ 8KΩ

General Purpose Chip Resistors (1Ω~10MΩ)

Feature

1. High reliability and stability
2. Reduced size of final equipment
3. Lower assembly costs
4. Higher component and equipment reliability
5. RoHs compliant and lead free products

Application

1. Consumer electrical equipment, PDA Digital Camcorder,
2. EDP, Computer application
3. Mobile phone, Telecom
4. Power supply, Battery charger, DC-DC power converter
5. Digital meter
6. Automotive.

Description

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is Tin solder (Pb free) alloy.

Quick Reference Data

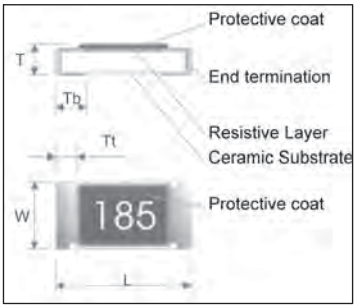
Series No.	WR25X	WR20X	WR18X	WR10X	WR12X	WR08X	WR06X	WR04X	WR02X	WR01X
Size code	2512 (6432)	2010 (5025)	1218 (3248)	1210 (3225)	1206 (3216)	0805 (2012)	0603 (1608)	0402 (1005)	0201 (0603)	01005 (0402)
Resistance Range ±5% Tolerance (E24) ±1% Tolerance (E24+E96)	±5% (E24): 1Ω~10MΩ;Jumper ±1% (E2+E964): 1Ω~10MΩ									
TCR (ppm/℃) R>1MΩ 1MΩ≧R>10Ω R≦10Ω	≦±200 ≦±100 ≦±200		≦±200 ≦±100 ≦±200		≦±100 ≦±100 ≦±200				≦±200 ≦±300	≦±200 ≦±300
Max. dissipation @ Tamb=70℃	1.0 W	1/2 W	1.0 W	1/3 W	1/4 W	1/8 W	1/10 W	1/16 W	1/20 W	1/32 W
Max. Operation Voltage (DC or RMS)	250V	200V	200V	200V	200V	150V	50V	50V	25V	20V
Operation Temperature	-55 ~ +155								-55 ~ +125	
Basic Specification	JIS C 5201-1 / IEC 60115-1									

Note:
1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8".
2. Max. Operation Voltage: So called RCWW (Rated Continuous Working Voltage) is determined by
   RCWV=√Rater Power ×Resistance Value or Max. RCWV listed above, whichever is lower.
3. Detailed TCR please refer to specific specification.

Physical Dimensions

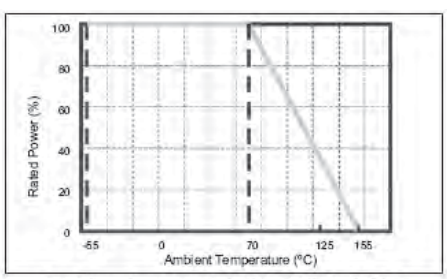
Unit: mm

Size	2512 (6432)	2010 (5025)	1218 (3248)	1210 (3225)	1206 (3216)	0805 (2012)	0603 (1608)	0402 (1005)	0201 (0603)	01005 (0402)
L	6.40±0.20	5.00±0.20	3.05±0.15	3.10±0.10	3.10±0.10	2.00±0.10	1.60±0.10	1.00±0.05	0.60±0.03	0.40±0.02
W	3.20±0.20	2.50±0.20	4.60±0.20	2.60±0.10	1.60±0.10	1.25±0.10	0.80±0.10	0.50±0.05	0.30±0.03	0.20±0.02
T	0.60±0.10	0.55±0.10	0.55±0.10	0.55±0.10	0.60±0.15	0.50±0.15	0.45±0.15	0.35±0.05	0.23±0.03	0.13±0.02
Tb	0.90±0.25	0.60±0.25	0.50±0.25	0.50±0.20	0.45±0.20	0.40±0.20	0.30±0.15	0.25±0.10	0.15±0.05	0.10±0.03
Tt	0.65±0.25	0.65±0.25	0.45±0.25	0.50±0.20	0.50±0.20	0.40±0.20	0.30±0.10	0.20±0.10	0.50±0.20	0.08±0.03

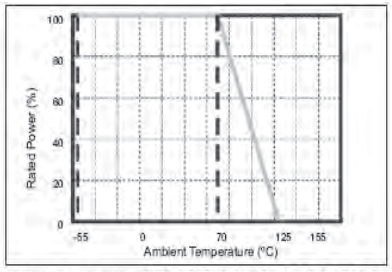


Power Deration Curve

For resistors operated in ambient temperature over 70℃, power rating should be derated in accordance with the following figures.



For Climatic category (IEC 60068) 55/155/56



For Climatic category (IEC 60068) 55/125/56 (for 0201 type)

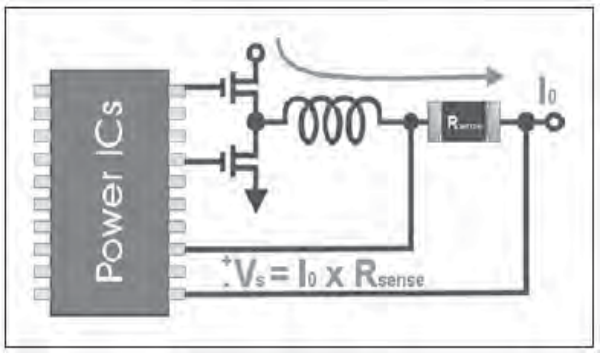
Thick Film Low Ohm/Power Low Ohm Chip Resistors

Function For Low Ohm Chip Resistors

The low ohmic resistors are used to sense output current in power supply, automotive and engine control management system, and other power sensing application. As shows in figure below, the typical function of low ohmic (power) chip resistor is to be a current sensor (Rsense) to generate the sensing voltage (Vs) for the purpose of feedback control when output current (Io) passed on it . The sensing voltage be treated as a signal to trigger the switches (CMOS) ON/OFF duration so that to monitor and/or adjust the output current from inductor.
Simplify to say, Vs=Io ×Rsense.
In general case, this feedback voltage is setting around 100mV for considering both on power saving and noise robustness. To sense a 5 ampere average output current, the Rsense resistance value therefore be required as 100mV / 5A = 20 mΩ, the power dissipation will be :

P=I2 ×R =5A2 ×20mΩ =0.5Watt

A low ohmic chip resistor with a power rating of 1.0 watt is recommended on this application in case the power safety margin is taken into account.



Quick Reference Data of Low Ohm Chip Resistor

Series No.	WW25X	WW20X	WW18X	WW10X	WW12X	WW08X	WW06X	WW04X
Size code	2512 (6432)	2010 (5025)	1218 (3248)	1210 (3225)	1206 (3216)	0805 (2012)	0603 (1608)	0402 (1005)
Resistance Tolerance	±5% , ±1%							
Resistance Range	0.020Ω ~ 0.976Ω						0.100Ω ~ 0.976Ω	
TCR (ppm/℃)	Detailed TCR please refer to specific data sheets							
Max. dissipation @ Tamb=70℃	1 Watt	0.5 Watt	1 Watt	1/3 Watt	1/4 Watt	1/8 Watt	1/10 Watt	1/16 Watt
Max. Operation Voltage (DC or RMS)	250V	200V	200V	200V	200V	100V	50V	50V
Operation Temperature	-55 ~ +155							
Basic Specification	JIS C 5201-1 / IEC 60115-1							

Note :
1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-9" .
2. Power derating curve, and detail specification please refer to specific data sheets.
3. Resistance value will be changed by soldering condition and design of solding pad, please design products in consideration of change of resistance value.

Quick Reference Data of Power Low Ohm Chip Resistor

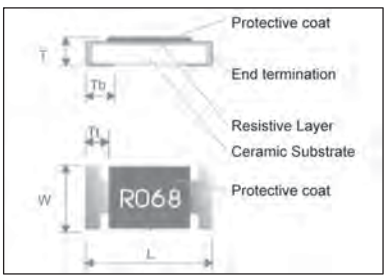
Item	General Specification					
Series No.	WW25P	WW20P	WW12P	WW08P	WW06P	WW04P
Size code	2512 (6432)	2010 (5025)	1206 (3216)	0805(2012)	0603(1608)	0402(1005)
Resistance Tolerance	±5% , ±1%					
Resistance Range	0.047Ω ~ 0.976Ω					0.1Ω~0.976Ω
TCR (ppm/℃) ＜0.100Ω	±150ppm/℃	±150ppm/℃	±200ppm/℃	±200ppm/℃	±250ppm/℃	-
≧0.100Ω	±100ppm/℃	±100ppm/℃	±100ppm/℃	±150ppm/℃	±200ppm/℃	0~+300ppm/℃
Max. dissipation @ Tamb=70℃	2 W	1 W	1/2 W	1/3 W	1/4 W	1/8 W
Max. Operation Voltage (DC or RMS)	300V	200V	200V	150V	50V	50V
Operation Temperature	-55 ~ +155					

Note :
1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8" .
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by
   RCWV=√Rater Power ×Resistance Value or Max. RCWV listed above, whichever is lower.
3. 2W loading with total solder-pad and trace size of 300mm2

Physical Dimensions

Unit: mm

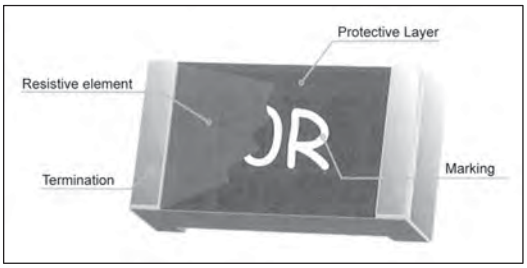
Dimensions	WW25P	WW20P	WW12P	WW08P	WW06P	WW04P
L	6.30±0.20	5.00±0.20	3.10±0.15	2.00±0.15	1.60±0.10	1.00±0.05
W	3.10±0.20	2.50±0.20	1.60±0.15	1.20±0.15	0.80±0.10	0.50±0.05
T	0.60±0.15	0.60±0.10	0.55±0.10	0.50±0.10	0.45±0.10	0.35±0.05
Tt	0.60±0.25	0.60±0.25	0.50±0.25	0.40±0.20	0.30±0.20	0.20±0.10
Tb	1.80±0.25	0.65±0.25	0.50±0.25	0.40±0.20	0.30±0.20	0.25+0.05/-0.1



Metal Low Ohm Sensing Chip Resistors (0.001Ω~ 0.050Ω)

Description

The resistors are constructed in a high grade low resistive metal body. The resistive layer is covered with a protective coat and printed a resistance marking code over it. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a lead free terminations.



Quick Reference Data

Item	General Specification					
Series No.	WW25R	WW25Q	WW12R	WW12D	WW08D	WW06R
Size code	2512 (6432)		1206(3216)		0805 (2012)	0603 (1608)
Resistance Tolerance	±5% , ±1%					
Resistance Range	1,2,3,4,5,6,7,10mΩ	1 ~ 15mΩ	1,4, 5, 6, 8, 10, 15mΩ	20, 25, 30, 40, 50mΩ	20, 25, 30, 40, 50mΩ	5, 10, 15mΩ
TCR (ppm/℃)	±100ppm		±100ppm		±100ppm	±100ppm
Max. dissipation @ Tamb=70℃	2 W	1 W	1 W	1 W	1/2 W	1/3 W
Max. Operation Current (DC or RMS)	44.7A		14A		5A	8.1A
Operation Temperature	-55 ~ +155					

Item	General Specification					
Series No.	WW25M	WW25N	WW20M	WW20N	WW12N	WW12M
Size code	2512 (6432)		2010 (5025)		1206(3216)	
Resistance Tolerance	±5% , ±1%					
Resistance Range	1~10, 12, 15, 20, 25, 30, 40, 50mΩ	1~10, 12, 15, 20, 25mΩ	5, 10, 15, 20mΩ		5, 10, 15, 20, 25mΩ	
TCR (ppm/℃)	1-4mΩ: ±100ppm; > 4m: ± 75 ppm/℃		± 75 ppm/℃		± 70 ppm/℃	
Max. dissipation @ Tamb=70℃	1 W	2 W	1/2 W	1 W	1 W	1/2 W
Max. Operation Voltage (DC or RMS)	250V		250V		200V	
Max. Overload Voltage (DC or RMS)	500V		500V		400V	
Operation Temperature	-55 ~ +155					

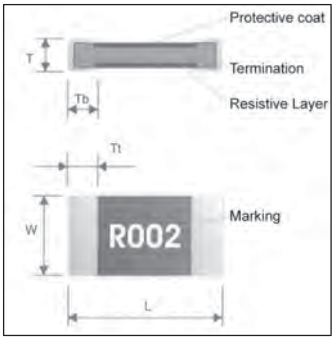
Note :
1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8” .
2. Power derating curve, and detail specification please refer to specific data sheets.
3. Resistance value will be changed by soldering condition and design of solding pad, please design products in consideration of chang of resistance value.

Physical Dimensions:

WW25M(0.002Ω~0.025Ω), WW25N(0.003Ω~0.025Ω), WW20N, WW12N

Unit: mm

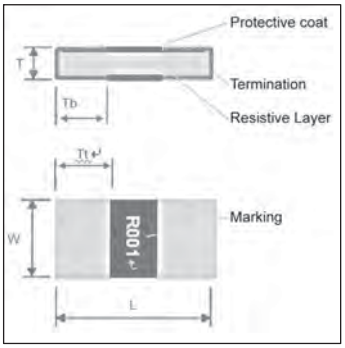
Symbol	2512	2010	1206
L	6.40±0.20	5.00±0.20	3.10±0.20
W	3.20±0.20	2.50±0.20	1.60±0.20
T	0.60±0.15	0.60±0.15	0.60±0.25
Tt	0.65±0.25	0.65±0.25	0.60±0.20
Tb	0.65±0.25	0.65±0.25	0.60±0.20



WW25M(0.001Ω), WW25N(0.001Ω~0.002Ω)

Unit: mm

Symbol	2512
L	6.40±0.20
W	3.20±0.20
T	0.60±0.10
Tt	1.60±0.25
Tb	1.60±0.25



WW25Q, WW25R, WW12R, WW12D, WW06R

Note : 1. The detailed dimensions please refer to data sheet per type!

Chip Resistors Array : Convex Termination

Feature

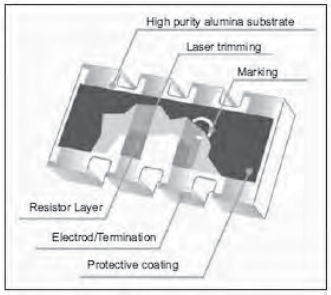
1. High reliability and stability
2. Reduced size of final equipment
3. Lower assembly cost and higher surface mounted efficiency
4. Higher component and equipment reliability

Application

1. Consumer electrical equipment, PDA Digital Camcorder,
2. EDP, Computer application
3. Mobile phone, Telecom
4. DIMM

Description and Physical Dimensions

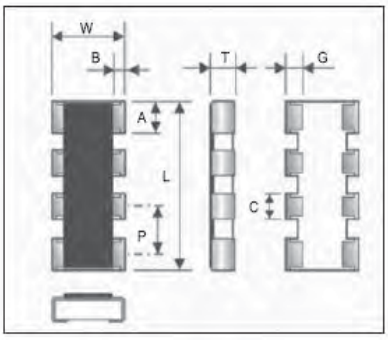
The resistors array is constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.
The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end termination is Tin solder alloy. Marking code description is depended on component size and tolerance. Following figure shown the construction of a Chip-R array.



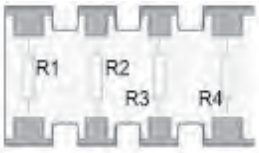
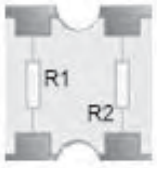
Physical Dimensions

Unit: mm

Type	WA06X	WA04X	WA06Y	WA04Y
L	3.20±0.10	2.00±0.10	1.60±0.10	1.00±0.10
W	1.60±0.10	1.00±0.10	1.50±0.10	1.00±0.10
T	0.50±0.10	0.45±0.10	0.50±0.10	0.35±0.10
P	0.80±0.10	0.50±0.05	1.00±0.10	0.65±0.10
A	0.60±0.10	0.40±0.10	0.60±0.10	0.34±0.10
B	0.30±0.10	0.20±0.10	0.30±0.15	0.20±0.15
C	0.40±0.10	0.30±0.05	-	-
G	0.30±0.20	0.25±0.10	0.30±0.15	0.25±0.17



Quick Reference Data

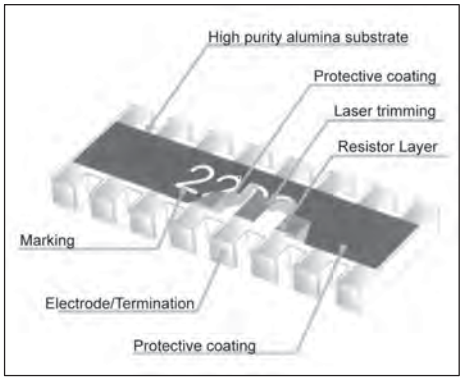
Series No.	WA06X	WA04X	WA06Y	WA04Y
Size	0603×4(1608×4)	0402×4(1005×4)	0603×2(1608×4)	0402×2(1005×2)
Termination construction	8P4R,Convex		4P2R,Convex	
Resistance Tolerance	±5%, ±1% (E24 series)			
Resistance Range	10Ω~1MΩ(E24 series), Jumper (0Ω)			
TCR (ppm/℃)	±200 ppm/℃			
Max. dissipation @ Tamb=70℃	1/10 Watt	1/16 Watt	1/10 Watt	1/16 Watt
Max. Operation Voltage (DC or RMS)	50V	50V	1/10 Watt	1/16 Watt
Max. Overload Voltage (DC or RMS)	100V	100V	1/10 Watt	1/16 Watt
Operation Temperature	-55 ~ +155			
Basic Specification	JIS C5201-1 / IEC 60115-1			
Circuit Mode: R1=R2(=R3=R4)				

Note :
Power derating curve and detail specification please refer to specific data sheets.

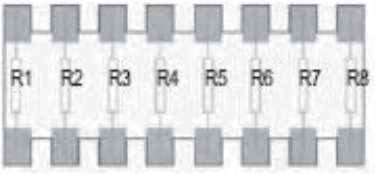
WA06W Chip Resistors Array 16P8R

Description

The resistors array is constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.
The resistors layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end termination is Tin (Pb free) solder alloy.



Quick Reference Data

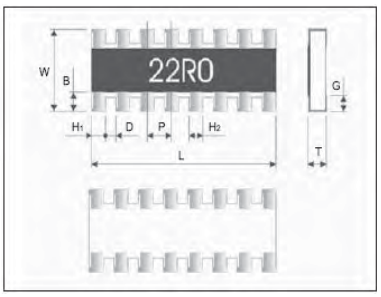
Item	General Specification	
Series No.	WA06W	WA06W_N
Size	1606 (0602×8)	1606 (0602×8)
Termination construction	Convex type	Convex type
Resistance Tolerance	±5% (E24 series)	±5% (E24 series)
Resistance Range	10Ω~100KΩ, Jumper (0Ω)	10Ω~100KΩ, Jumper (0Ω)
TCR (ppm/℃)	± 200 ppm/℃	± 200 ppm/℃
Max. dissipation @ Tamb=70℃	1/16 W	1/16 W
Max. Operation Voltage (DC or RMS)	50V	25V
Max. Overload Voltage (DC or RMS)	100V	50V
Carrier Tape width	12mm	8mm
Operation Temperature	-55 ~ +155	
Circuit Mode: R1=R2=R3=R4=R5=R6=R7=R8		

Note :
Power derating curve and detail specification please refer to specific data sheets.

Physical Dimensions:

Unit: mm

Symbol	WA06W	WA06W_N
L	4.00±0.20	3.80±0.10
W	1.60±0.15	1.60±0.10
T	0.45±0.10	0.45±0.10
B	0.30±0.20	0.30±0.10
G	0.30±0.20	0.30±0.10
D	0.20±0.10	0.20±0.10
P	0.50±0.20	0.50±0.10
H1	0.40±0.20	0.30±0.10
H2	0.30±0.10	0.30±0.10



Chip Resistors Array : Concave Termination

Feature

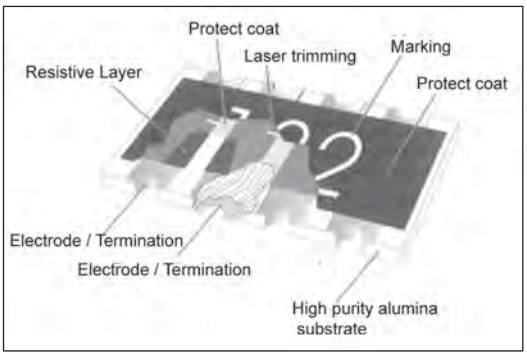
1. High reliability and stability
2. Reduced size of final equipment
3. Lower assembly cost and higher surface mounted efficiency
4. Higher component and equipment reliability
5. Strong body and terminations
6. Excellent performance in surface mounting assembly.

Application

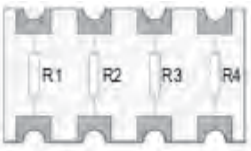
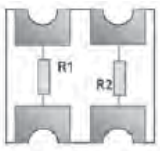
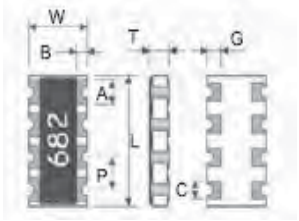
1. Consumer electrical equipment, PDA Digital Camcorder,
2. EDP, Computer application
3. Mobile phone, Telecom
4. DIMM

Description and Physical Dimensions

The resistor array is constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.
The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end termination is Tin solder alloy. Marking code description is depended on component size and tolerance. Following figure shown the construction of a Chip-R array.



Quick Reference Data

Item	General Specification		
Series No.	WA06T	WA04T	WA04U
Size	0603×4 (1608×4)	0402×4 (1005×4)	0402×2 (1005×2)
Termination construction	Concave type		
Resistance Tolerance	±5% , ±1% (E24 series)		
Resistance Range	10Ω~1MΩ, Jumper (0Ω)		
TCR (ppm/℃)	± 200 ppm/℃	± 300 ppm/℃	± 300 ppm/℃
Max. dissipation @ Tamb=70℃	1/10 W	1/16 W	1/16 W
Max. Operation Voltage (DC or RMS)	50V	25V	25V
Max. Overload Voltage	100V	50V	50V
Operation Temperature	-55 ~ +155		
Circuit Mode	 R1=R2=R3=R4		 R1 = R2
	L	3.20+0.20/-0.10mm	2.00±0.10mm	1.00±0.10mm
	W	1.60+0.20/-0.10mm	1.00±0.10mm	1.00±0.10mm
	T	0.60±0.20mm	0.45±0.10mm	0.30±0.10mm
	P	0.80±0.10mm	0.50±0.05mm	0.50±0.05mm
	A	0.60±0.15mm	0.35±0.05mm	0.35±0.10mm
	B	0.35±0.15mm	0.20±0.15mm	0.25±0.15mm
	C	0.50±0.15mm	0.25±0.05mm	0.35±0.10mm
	G	0.50±0.15mm	0.25±0.15mm	0.25±0.15mm

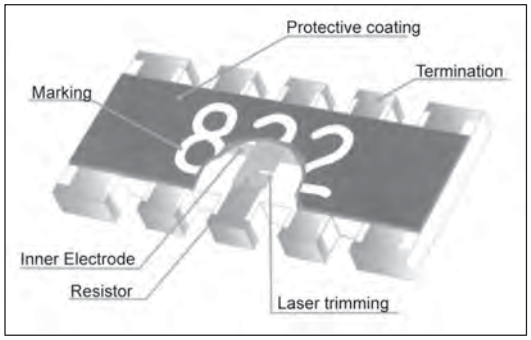
Note :
1. Power derating curve and detail specification please refer to specific data sheets.
2. Max. Operation Voltage : So called RCWW (Rated Continuous Working Voltage) is determined by
RCWV = √Rater Power × Resistance Value or Max. RCWV listed above, whichever is lower.

WT04X Chip Resistor Network 10P8R

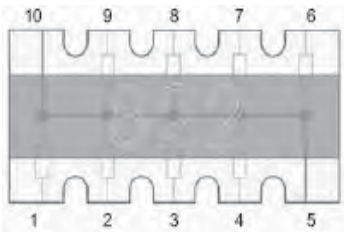
Description

The resistor array is constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end termination is Tin (Pb free) solder alloy.



Quick Reference Data

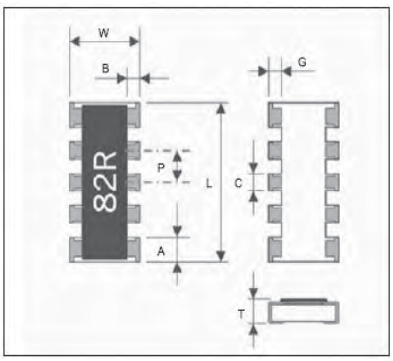
Item	General Specification
Series No.	WT04X
Size	0402x8 (1005x8)
Termination construction	Convex type
Resistance Tolerance	±5% (E24 series)
Resistance Range	10Ω ~ 100KΩ
TCR (ppm/℃)	± 200 ppm/℃
Max. dissipation @ Tamb=70℃	1/16 W
Max. Operation Voltage (DC or RMS)	25V
Max. Overload Voltage (DC or RMS)	50V
Operation Temperature	-55 ~ +155
Circuit Mode: Resistor elements on pin1 ~ pin4, pin6 ~ pin9; R1=R2=R3=R4=R6=R7=R8=R9	

Note :
1. Power derating curve and detail specification please refer to specific data sheets.

Physical Dimensions:

Unit: mm

Symbol	
L	3.30±0.20
W	1.60±0.15
T	0.55±0.10
P	0.64±0.05
A	0.50±0.05
B	0.40±0.15
C	0.40±0.15
G	0.40±0.15

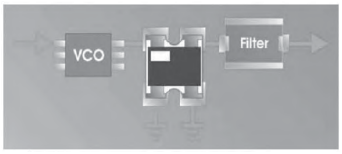


WA04P Chip Attenuator

Typical Application of Chip Attenuator

WA04	P	001	X	B	T	L
Size code	**Type code**	**Attenuation Range**	**Characteristic Impedance**	**Attenuation Tolerance**	**Termination**	**Packaging**
WA04: 0402 per element	P: convex, π type attenuator	000 = 0dB R05 = 0.5dB 001 = 1dB R15 = 1,5dB 002 = 2dB 003 = 3dB 004 = 4dB 005 = 5dB 006 = 6dB 007 = 7dB 008 = 8dB 009 = 9dB 010 =10dB 011 = 11dB 012 = 12dB 013 = 13dB 014 = 14dB 015 = 15dB 016 = 16dB 017 = 17dB 018 = 18dB 019 = 19dB 020 = 20dB	X:50Ω	A : ± 0.1dB B : ± 0.3dB C : ± 0.4dB D : ± 0.8dB E : ± 1.0dB F : ± 1.5dB G : ± 2.0dB H : ± 2.5dB P : -	T=7" reel taped	L=Sn base (lead free)

π type Attenuator (-6dB, 50W) for VSWR improvement and output frequency level matching on VCO application.

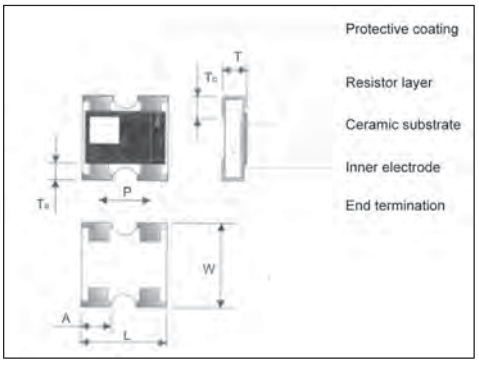


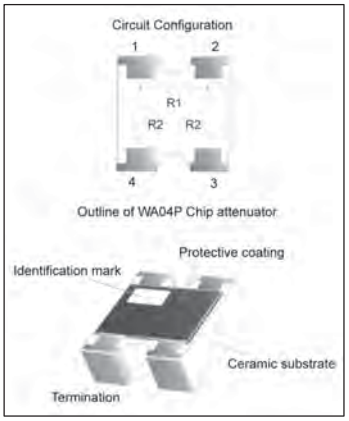
Quick Reference Data

Item	General Specification
Series No.	WA04P
Size	0402×2 (1005×2)
Termination construction	Convex type
Attenuation Range	0dB, 0.5dB ~ 20dB
Attenuation Tolerance 0dB 0.5dB 1dB~ 5dB 6dB~ 10dB 11dB~ 13dB 14dB 15dB~ 16dB 17dB~ 19dB 20dB	 - ± 0.1dB ± 0.3dB ± 0.4dB ± 0.8dB ± 1.0dB ± 1.5dB ± 2.0dB ± 2.5dB
Characteristic impedance	50Ω
Rated power at Tamb=70℃	0.1 W / package
Limiting Voltage (DC)	50V
Frequency range (DC)	MAX. 3 GHz
VSWR (Voltage Standing Wave Ratio)	MAX. 1.2
Number of Resistors	3 resistors
Number of Terminals	4 terminals
Operation Temperature	-40 ~ 125'C

Physical Dimensions:

Unit: mm	WA04P
L	1.00±0.10
W	1.00+0.10/-0
T	0.35±0.10
P	0.65±0.20
A	0.33±0.10
Ta	0.15±0.10
Tb	0.25±0.10





Special Application Chip Resistors

Feature

1. Provided Automotive & Anti-sulfuration resistors (MR/SR series) for Auto & Anti-sulfuration application.
2. Provided Total Lead Free resistors (WR_R series) to fulfill RoHS environmental regulation.
3. Provided trimmable resistors (WKxxM series) for customer special tolerance requirement.
4. Provided high precision tolerance (WFxxH/ WFxxT/ WFxxU/ WFxxW) down to ±0.05% and TCR down to 10ppm/℃ for voltage sensing.
5. High reliability and stability.
6. Reduced size of final equipment
7. Lower assembly costs.
8. Higher component and equipment reliability
9. Special resistance, tolerance are available upon customer's request.

MR/SR Series of Automotive & Anti-sulfuration Chip Resistor

Feature

1. High reliability and stability ±1%.
2. Sulfuration resistant
3. Automotive grade AEC Q-200 compliant.
4. 100% CCD inspection.
5. RoHS compliant and lead free.

Application

1. Automotive application.
2. Consumer electrical equipment.
3. EDP, Computer application.
4. Telecom Application.

Quick Reference Data

Series No.	MR12X	MR08X	MR06X	MR04X
Size code	1206(3126)	0805(2012)	0603(1608)	0402(1005)
Resistance Range	1Ω~10MΩ (±1% , ±5%) ,Jumper			
TCR (ppm/℃)	±200 ppm*			
Max. dissipation @ Tamb=70℃	1/4 W	1/8 W	1/10 W	1/16 W
Max. Operation Voltage (DC or RMS)	200V	150V	75V	50V
Operation Temperature	-55 ~ +155			

Series No.	SR12X	SR08X	SR06X	SR04X
Size code	1206(3126)	0805(2012)	0603(1608)	0402(1005)
Resistance Range	1Ω~10MΩ (±1% , ±5%) ,Jumper			
TCR (ppm/℃)	±200 ppm*			
Max. dissipation @ Tamb=70℃	1/4 W	1/8 W	1/10 W	1/16 W
Max. Operation Voltage (DC or RMS)	200V	150V	75V	50V
Operation Temperature	-55 ~ +155			

Remark: *Detail specification please refer to specific data sheets!
*MR series can withstand H2S 3ppm×1000hrs.
*SR series can withstand H2S 1000ppm×720hrs.

WR_R Series of Total Lead Free Chip Resistors

Feature

1. High reliability and stability
2. Reduced size of final equipment
3. Lower assembly cost
4. Higher component and equipment reliability
5. RoHS compliant and total lead free

Quick Reference Data

Series No.	MR12X	MR08X	MR06X	MR04X
Size code	1206(3126)	0805(2012)	0603(1608)	0402(1005)
Resistance Range	1Ω~10MΩ (±1% , ±5%) ,Jumper			
TCR (ppm/℃)	±200 ppm*			
Max. dissipation @ Tamb=70℃	1/4 W	1/8 W	1/10 W	1/16 W
Max. Operation Voltage (DC or RMS)	200V	150V	50V	50V
Operation Temperature	-55 ~ +155			

Remark: *Detail specification please refer to specific data sheets!

Part No. Definition

1st code	2nd code	3rd ~ 4th code	5th code	6th ~ 9th code	10th code	11th code	12th code
□	□	□□	□	□□□□	□	□	R
WTC	Type code	Size code	Functional code	Marking code (Resistance)	Tolerance code	Packaging code	Termination code
For example:							
W	R	04	X	1000	F	T	R

WKxxM Series of Trimmable Chip Resistors

Feature

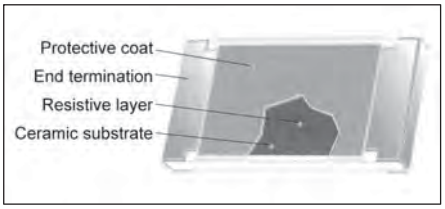
1. High precision, reliability and stability
2. Miniature size down to 00603 (1608)

Application

1. Automotive application.
2. Consumer electrical equipment.
3. EDP, Computer application.
4. Telecom Application.

Description

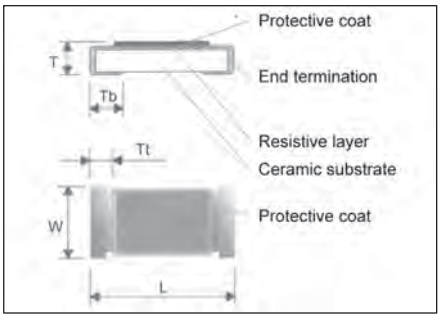
The resistors are constructed on a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste
that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required.
The resistive layer is covered with a transparent protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end termination is Tin (Pb free) solder alloy.



Physical Dimensions

Unit: mm

Type	WK25M	WK20M	WK10M	WK12M	WK08M	WK06M
L	6.30±0.15	5.00±0.15	3.10±0.15	3.10±0.15	2.00±0.10	1.60±0.10
W	3.20±0.15	2.50±0.15	2.50±0.15	1.60±0.15	1.25±0.10	0.80+0.15/-0.10
T	0.55±0.15	0.55±0.15	0.55±0.15	0.55±0.10	0.55±0.10	0.45±0.10
Tb	0.60±0.20	0.60±0.20	0.50±0.25	0.50±0.25	0.40±0.20	0.30±0.10
Tt	0.60±0.20	0.60±0.20	0.50±0.25	0.50±0.25	0.40±0.20	0.30±0.10



Quick Reference Data

Series No.	WK25M	WK20M	WK10M	WK12M	WK08M	WK06M
Size code	2512 (6332)	2010 (5025)	1210(3225)	1206(3216)	0805(2012)	0603(1608)
Resistance Tolerance	0/-20%(Y) and 0/-30%(X) E24 series					
Resistance Range	1Ω ~ 4.7MΩ					10Ω ~ 4.7MΩ
TCR (ppm/℃)	10Ω ~ 4.7MΩ: ±200 ppm/℃ 1Ω ~ 9.1Ω: - 200 ~ +500 ppm/℃					±200 ppm/℃
Max. dissipation @ Tamb=70℃	1 W	1/2 W	1/4 W	1/8 W	1/10 W	1/16 W
Max. Operation Voltage (DC or RMS)	200V	200V	200V	200V	150V	50V
Operation Temperature	-55 ~ +125					
Basic Specification	JIS C 5201-1 / IEC 60115-1					

WKxxV Series of High Voltage Chip Resistors

Feature

1. Special material and design for high working voltage required
2. Compatible with flow and reflow soldering.
3. Suitable for lead free soldering.

Application

1. Power supply.
2. Automotive industry.
3. Measurement instrument.
4. Back light inverter.
5. Medical or Military equipment

Quick Reference Data

Series No.	WK25V	WK20V	WK12V	WK08V	WK06V
Size code	2512 (6332)	2010 (5025)	1206(3216)	0805(2012)	0603(1608)
Resistance Tolerance	±5% ; ±1%				
Resistance Range	47Ω ~ 51MΩ				47Ω ~ 10MΩ
TCR (ppm/℃)	± 200 ppm/℃ * detail refer to data sheet				
Max. dissipation @ Tamb=70℃	1 W	1/2 W	1/4 W	1/8 W	1/10 W
Max. Operation Voltage (DC or RMS)	800V	500V	500V	400V	200V
Operation Temperature	-55 ~ +125				

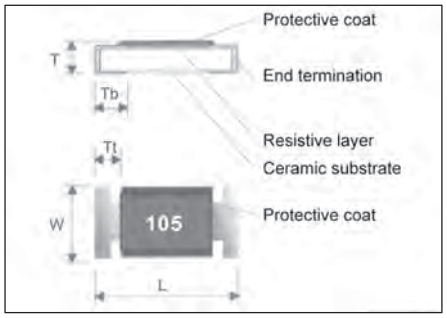
Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8” .
2. Max. Operation Voltage : So called RCWW (Rated Continuous Working Voltage) is determined by RCWV=√Rater Power ×Resistance Value or Max. RCWV listed above, whichever is lower.

Physical Dimensions

Unit: mm

Symbol	WK25V	WK20V	WK12V	WK08V	WK06V
L	6.30±0.15	5.00±0.15	3.10±0.15	2.00±0.10	1.60±0.10
W	3.20±0.15	2.50±0.15	1.60±0.15	1.25±0.10	0.80+0.15/-0.10
T	0.55±0.15	0.55±0.15	0.55±0.10	0.55±0.10	0.45±0.10
Tt	0.60±0.20	0.60±0.20	0.50±0.25	0.40±0.20	0.30±0.10
Tb	0.60±0.20	0.60±0.20	0.50±0.25	0.40±0.20	0.30±0.10



WFxxP Series of High Power Chip Resistors

Feature

1. High power rating and compact size
2. High reliability and stability
3. Reduced size of final equipment
4. Lead free product is upon customer requested

Application

1. Power supply
2. PDA
3. Digital meter
4. Computer
5. Automotives.

Quick Reference Data

Item	General Specification						
Series No.	WF25P	WF20P	WF10P	WF12P	WF08P	WF06P	WF04P
Size code	2512(6432)	2010(5025)	1210(3225)	1206(3216)	0805(2012)	0603 (1608)	0402(1005)
Resistance Tolerance	±1% , ±5%						
Resistance Range	0Ω, 1Ω ~ 1MΩ						
TCR (ppm/℃)	± 100 ppm/℃						
Max. dissipation @ Tamb=70℃	2W	1W	1/2W	1/2W	1/4W	1/8W	1/8W
Max. Operation Voltage (DC or RMS)	300V	200V	200V	200V	150V	50V	50V
Operation Temperature	-55 ~ +155						

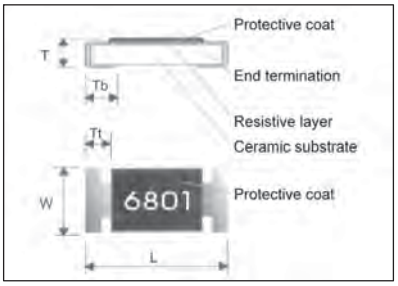
Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8”.
2. Max. Operation Voltage : So called RCWW (Rated Continuous Working Voltage) is determined by
   RCWV=√Rater Power xResistance Value or Max. RCWV listed above, whichever is lower.
3. 2W loading with total solder-pad and trace size of 300mm^2
4. 0Ω maximum resistance Rmax＜15mΩ and rated current＜4Amp

Physical Dimensions

Unit: mm

Symbol	WF25P	WF20P	WF10P	WF12P	WF08P	WF06P	WF04P
L	6.30±0.20	5.00±0.20	3.10±0.10	3.10±0.15	2.00±0.15	1.60±0.10	1.00±0.05
W	3.10±0.20	2.50±0.20	2.60±0.10	1.60±0.15	1.20±0.15	0.80±0.10	0.50±0.05
T	0.60±0.15	0.60±0.10	0.55±0.10	0.55±0.10	0.50±0.10	0.45±0.10	0.35±0.05
Tt	0.60±0.25	0.60±0.25	0.50±0.20	0.50±0.25	0.40±0.20	0.30±0.20	0.25±0.10
Tb	1.80±0.25	0.60±0.25	0.50±0.20	0.50±0.25	0.40±0.20	0.30±0.20	0.25±0.10



WKxxS Series of Anti-Surge Chip Resistors

Feature

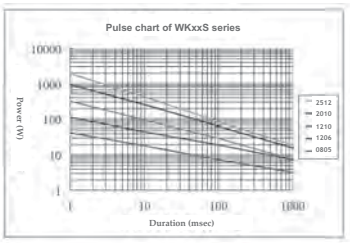
1. Power rating and compact size
2. High reliability and stability
3. Reduced size of final equipment
4. Surge protection

Application

1. Power supply.
2. Measurement instrument.
3. Automotive industry.
4. Medical or Military equipment.

Quick Reference Data

Item	General Specification				
Series No.	WK25S	WK20S	WK10S	WK12S	WK08S
Size code	2512(6432)	2010(5025)	1210(3225)	1206(3216)	0805(2012)
Resistance Tolerance	±5% ,±10% ,±20%,(E24)				
Resistance Range	0.27Ω ~ 22MΩ				
TCR (ppm/℃)	± 200 ppm/℃				
Max. dissipation @ Tamb=70℃	1 W	3/4W	1/2W	1/4W	1/8W
Max. Operation Voltage (DC or RMS)	200V				150V
Operation Temperature	-55 ~ +155				



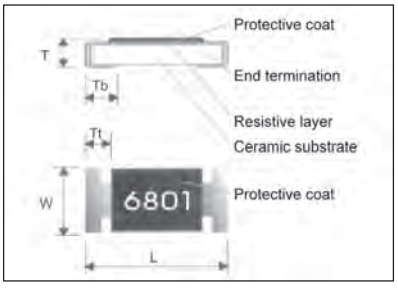
Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8” .
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by
   RCWV=√Rater Power xResistance Value or Max. RCWV listed above, whichever is lower.

Physical Dimensions

Unit: mm

Symbol	WK25S	WK20S	WK10S	WK12S	WK08S
L	6.30±0.15	5.00±0.15	3.20±0.15	3.20±0.15	2.00±0.10
W	3.20±0.15	2.50±0.15	2.50±0.15	1.60±0.15	1.25±0.10
T	0.55±0.15	0.55±0.15	0.55±0.15	0.55±0.10	0.55±0.10
Tt	0.30±0.15	0.30±0.15	0.30±0.20	0.30±0.20	0.30±0.20
Tb	0.60±0.20	0.60±0.20	0.50±0.25	0.50±0.25	0.40±0.20



High Precision Chip Resistors

Narrow Tolerance Thick Film TC100 WFxxH Series

Series No.	WF12H	WF08H	WF06H	WF04H
Size	1206(3216)	0805(2012)	0603(1608)	0402(1005)
Resistance Tolerance	±0.5% , ±0.1%			
Resistance Range	10Ω ~ 1MΩ (E96+E24 series)			
TCR (ppm/℃)	±100 ppm/℃			
Max. dissipation @ Tamb=70℃	1/4 W	1/8 W	1/10 W	1/16 W
Max. Operation Voltage (DC or RMS)	200V	100V	50V	50V
Operation Temperature	-55 ~ +155			
Basic Specification	JIS C5201-1 / IEC 60115-1			

(Detail specification please refer to specific data sheets)

Narrow Tolerance Thin Film TC50 WFxxT/ WFxxQ Series

Series No.	WF25T	WF25Q	WF20T	WF20Q	WF10T	WF10Q	WF12T	WF12Q	WF08T	WF08Q	WF06T	WF06Q	WF04T
Size	2512 (6432)	2512 (6432)	2010 (5025)	2010 (5025)	1210 (3225)	1210 (3225)	1206 (3216)	1206 (3216)	0805 (2012)	0805 (2012)	0603 (1608)	0603 (1608)	0402 (1005)
Resistance Tolerance	±1%, ±0.5% , ±0.1%, ±0.05%												
Resistance Range	10 ~ 1.5MΩ				10 ~ 1MΩ		4.7 ~ 1MΩ				4.7 ~ 680KΩ		10 ~ 100KΩ
TCR (ppm/℃)	±50 ppm/℃												
Max. dissipation @ Tamb=70℃	3/4W	1W	1/2W	3/4W	1/4W	2/5W	1/8W	1/4W	1/10W	1/8W	1/16W	1/10W	1/16W
Max. Operation Voltage (DC or RMS)	200V	200V	200V	200V	200V	200V	200V	200V	100V	150V	50V	75V	25V
Operation Temperature	-55 ~ +155												
Basic Specification	JIS C5201-1 / IEC 60115-1												

(Detail specification please refer to specific data sheets)

Narrow Tolerance Thin Film TC25 WFxxU/ WFxxR Series

Series No.	WF25U	WF25R	WF20U	WF20R	WF10U	WF10R	WF12U	WF12R	WF08U	WF08R	WF06U	WF06R	WF04U
Size	2512 (6432)	2512 (6432)	2010 (5025)	2010 (5025)	1210 (3225)	1210 (3225)	1206 (3216)	1206 (3216)	0805 (2012)	0805 (2012)	0603 (1608)	0603 (1608)	0402 (1005)
Resistance Tolerance	±1%, ±0.5% , ±0.1%, ±0.05%												
Resistance Range	10 ~ 1.5MΩ				10 ~ 1MΩ		4.7 ~ 1MΩ				4.7 ~ 680KΩ		10 ~ 100KΩ
TCR (ppm/℃)							±25 ppm/℃						
Max. dissipation @ Tamb=70℃	3/4W	1W	1/2W	3/4W	1/4W	2/5W	1/8W	1/4W	1/10W	1/8W	1/16W	1/10W	1/16W
Max. Operation Voltage (DC or RMS)	200V	200V	200V	200V	200V	200V	200V	200V	100V	150V	50V	75V	25V
Operation Temperature	-55 ~ +155												
Basic Specification	JIS C5201-1 / IEC 60115-1												

(Detail specification please refer to specific data sheets)

Narrow Tolerance Thin Film TC15 WFxxF Series

Series No.	WF12F	WF08F	WF06F	WF04F
Size	1206 (3216)	0805 (2012)	0603 (1608)	0402 (1005)
Resistance Tolerance	±0.5%, ±0.1%, ±0.05%			
Resistance Range	25 ~ 300KΩ	25 ~ 200KΩ	25 ~ 100KΩ	25 ~ 20KΩ
TCR (ppm/℃)	± 15 ppm/℃			
Max. dissipation @ Tamb=70℃	1/8W	1/8W	1/10W	1/16W
Max. Operation Voltage (DC or RMS)	150V	100V	50V	25V
Operation Temperature	-55 ~ +155			
Basic Specification	JIS C5201-1 / IEC 60115-1			

(Detail specification please refer to specific data sheets) * Sample is available upon request

Narrow Tolerance Thin Film TC10 WFxxW Series

Series No.	WF12W	WF08W	WF06W	WF04W
Size	1206(3216)	0805(2012)	0603(1608)	0402(1005)
Resistance Tolerance	±0.5% , ±0.1%, ±0.05%			
Resistance Range	25 ~ 300KΩ	25 ~ 200KΩ	25 ~ 100KΩ	25 ~ 20KΩ
TCR (ppm/℃)	± 10 ppm/℃			
Max. dissipation @ Tamb=70℃	1/8W	1/8W	1/10W	1/16W
Max. Operation Voltage (DC or RMS)	150V	100V	50V	25V
Operation Temperature	-55 ~ +155			
Basic Specification	JIS C5201-1 / IEC 60115-1			

(Detail specification please refer to specific data sheets)

Narrow Tolerance Thin Film TC5 WFxxZ Series

Series No.	WF12Z	WF08Z	WF06Z	WF04Z
Size	1206(3216)	0805(2012)	0603(1608)	0402(1005)
Resistance Tolerance	±0.5% , ±0.1%, ±0.05%			
Resistance Range	25 ~ 120KΩ	25 ~ 80KΩ	25 ~ 40KΩ	25 ~ 8KΩ
TCR (ppm/℃)	±5 ppm/℃			
Max. dissipation @ Tamb=70℃	1/8W	1/8W	1/10W	1/16W
Max. Operation Voltage (DC or RMS)	150V	100V	50V	25V
Operation Temperature	-55 ~ +155			
Basic Specification	JIS C5201-1 / IEC 60115-1			

(Detail specification please refer to specific data sheets)

Test and Requirements

For WR Series

Test	Procedure / Test Method	Requirements	
		Resistor	0Ω
Electrical Characteristics JISC5201-1: 1998 Clause 4.8	- DC resistance values measurement - Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. $[(R2-R1)/R1(T2-T1)]\times10^6$ (ppm /℃) T1:20℃+5℃-1℃ R1:Resistance at reference temperature (20℃+5℃/-1℃) R2:Resistance at test temperature (-55℃ or +155℃)	Within the specified tolerance Refer to “QUICK REFERENCE DATA”	＜50mΩ
Resistance to soldering heat(R.S.H) JISC5201-1:1998 Clause 4.18	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260℃±5ºC	±5%: △R/Rmax. (1%+0.05Ω) ±1%: △R/Rmax. (0.5%+0.05Ω) no visible damage	＜50mΩ
Solder ability JISC5201-1:1998 Clause 4.17	Un-mounted chips completely immersed for 2±0.5 second in a SAC solder bath at 235℃±5℃	95% coverage min., good tinning and no visible damage	
Temperature cycling JISC5201-1:1998 Clause 4.19	30minutes at -55℃±3℃, 2~3minutes at 20℃+5℃-1℃,30minutes at +155℃±3℃,2~3minutes at 20℃+5℃-1℃,total 5continuous cycles	±5%: △R/Rmax. (1%+0.05Ω) ±1%: △R/Rmax. (0.5%+0.05Ω) no visible damage	＜50mΩ
High Temperature Exposure MIL-STD-202 Mothod 108	1000+48/-0 hours; without load in a temperature chamber controlled 155℃±3℃	±5%: △R/Rmax. (2%+0.1Ω) ±1%: △R/Rmax. (1%+0.1Ω) no visible damage	＜50mΩ
Bending strength JISC5201-1:1998 Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR-4), bending once 3mm for 10sec, 5mm for WR04	±5%: △R/Rmax. (1%+0.05Ω) ±1%: △R/Rmax. (1%+0.05Ω) no visible damage	＜50mΩ
Adhesion JISC5201-1:1998 Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations	
Short Time Overload (STOL) JISC5201-1:1998 Clause 4.13	2.5 times RCWV or max. overload voltage, for 5seconds	±5%: △R/Rmax. (2%+0.1Ω) ±1%: △R/Rmax. (1%+0.1Ω) no visible damage	＜50mΩ
Load life in Humidity JISC5201-1:1998 Clause 4.24	1000+48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller 40℃±2℃at and 90~95% relative humidity, 1.5 hours on and 0.5 hours off	±5%: △R/Rmax. (2%+0.1Ω) ±1%: △R/Rmax. (1%+0.1Ω) no visible damage	＜50mΩ
Load life (endurance) JISC5201-1:1998 Clause 4.25	1000+48/-0 hours, loaded with RCWV or Vmax in chamber controller 70℃±2℃ 1.5 hours on and 0.5 hours off	±5%: △R/Rmax. (2%+0.1Ω) ±1%: △R/Rmax. (1%+0.1Ω) no visible damage	＜50mΩ
Insulation Resistance JISC5201-1:1998 Clause 4.6	Apply the maximum overload voltage (DC) for 1minute	R≧10GΩ	
Dielectric Withstand Voltage JISC5201-1:1998 Clause 4.7	Apply the maximum overload voltage (AC) for 1minute	No breakdown or flashover	

For WW Series

Test	Procedure / Test Method	Requirements Resistor
Electrical Characteristics JISC5201-1: 1998 Clause 4.8	- DC resistance values measurement - Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. $[(R2-R1)/R1(T2-T1)]\times10^6$ (ppm/℃) T1:20℃+5℃-1℃ R1:Resistance at referance temperature (20℃+5℃/-1℃) R2:Resistance at test temperature (-55℃ or +155℃)	Within the specified tolerance Refer to “QUICK REFERENCE DATA”
Resistance to soldering heat(R.S.H) JISC5201-1:1998 Clause 4.18	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260℃±5ºC	△R/R max. ±(1%+0.005Ω) no visible damge
Solder ability JISC5201-1:1998 Clause 4.17	Un-mounted chips completely immersed for 2±0.5 second in a SAC solder bath at 235℃±5℃	95% coverage min., good tinning and no visible damage
Temperature cycling JISC5201-1:1998 Clause 4.19	30minutes at -55℃±3℃, 2~3minutes at 20℃+5℃-1℃,30minutes at +155℃±3℃,2~3minutes at 20℃+5℃-1℃,total 5continuous cycles	△R/R max. ±(1%+0.005Ω) no visible damge
High Temperature Exposure MIL-STD-202 Method 108	1000+48/-0 hours; without load in a temperature chamber controlled 155℃±3℃	△R/R max. ±(3%+0.005Ω) no visible damge
Bending strength JISC5201-1:1998 Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR-4), bending once 3mm for 10sec, 5mm for WR04	△R/R max. ±(1%+0.005Ω) no visible damge
Adhesion JISC5201-1:1998 Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations
Short Time Overload (STOL) JISC5201-1:1998 Clause 4.13	2.5 times RCWV or max. overload voltage, for 5 seconds	△R/R max. ±(2%+0.005Ω) no visible damge
Load life in Humidity JISC5201-1:1998 Clause 4.24	1000+48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller 40℃±2℃at and 90~95% relative humidity, 1.5 hours on and 0.5 hours off	△R/R max. ±(3%+0.005Ω) no visible damge
Load life (endurance) JISC5201-1:1998 Clause 4.25	1000+48/-0 hours, loaded with RCWV or Vmax in chamber controller 70℃±2℃ 1.5 hours on and 0.5 hours off	△R/R max. ±(3%+0.005Ω) no visible damge
Insulation Resistance JISC5201-1:1998 Clause 4.6	Apply the maximum overload voltage (DC) for 1minute	R≧10GΩ
Dielectric Withstand Voltage JISC5201-1:1998 Clause 4.7	Apply the maximum overload voltage (AC) for 1minute	No breakdown or flashover

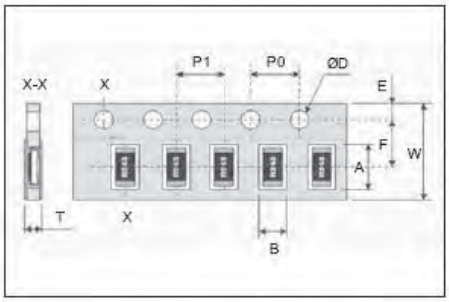
Packing on Tape and Reel

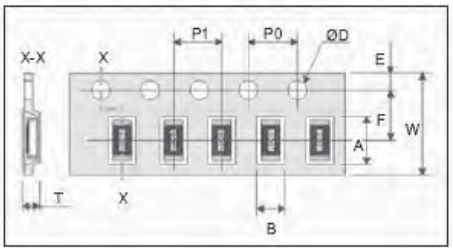
Paper Tape Specifications for WR,WF,WW Series and WA,WT Series

Unit: mm

Component Size / Series	W	F	E	PO	ΦD
1206, 0805, 0603, 0402, WA06X, WA06T, WA04X, WA04Y, WA04P, WA04T, WA04U, WT04X	8.00±0.30	3.50±0.20	1.75±0.10	4.00±0.10	Φ1.50+0.1
WA06W	12.0±0.10	5.50±0.05			
WR02X	8.00±0.20	3.50±0.05			

Component Size / Series	A	B	P1	T
1206(3216), WA06X, WA06T	3.60±0.20	2.00±0.20	4.00±0.10	Max. 1.0
0805(2012)	2.40±0.20	1.65±0.20		
0603(1608)	1.90±0.20	1.10±0.20		0.65±0.05
0402(1005)	1.20±0.10	0.70±0.10	2.00±0.10	0.40±0.05
WA04X, WA04T	2.20±0.20	1.20±0.20	2.00±0.05	Max. 0.6
WA04Y, WA04P, WA04U	1.15±0.10	1.15±0.10	2.00±0.05	0.45±0.05
WT04X	3.45+0.2/-0	1.85+0.2/-0	4.00±0.10	0.85±0.05
WA06W	4.20+0.2/-0	1.80+0.2/-0	4.00±0.10	0.65±0.05
WR02X	0.67±0.05	0.37±0.05	2.00±0.05	0.45±0.05

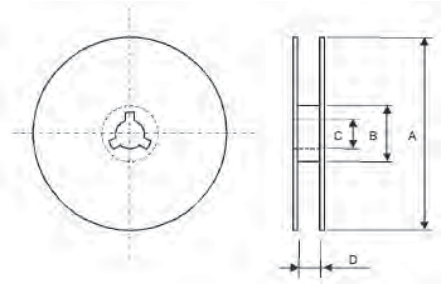




Plastic Tape Specifications for WR, WF, WW Series of Chip-R

Unit: mm

Component Size	2512(6432)	2010(5025)	1218(3248)
A	6.90±0.20	5.50±0.20	3.55±0.30
B	3.60±0.20	2.80±0.20	4.90±0.20
W	12.00±0.30		
F	5.50±0.10		
E	1.75±0.10		
P1	4.00±0.10		8.00±0.10
P0	4.00±0.10		
ΦD	Φ1.50+0.1		
T	Max. 1.2		



Plastic Tape Specifications for WR, WF, WW Series of Chip-R

Unit: mm

Reel/Tape	A	B	C	D
7"reel for 8mm tape	Φ178.0±0.20	Φ60.0±1.00	13.0±0.20	9.00±0.50
7"reel for 12mm tape				12.4±1.00
10"reel for 8mm tape	Φ254.0±2.00	Φ100.0±1.00	13.0±0.20	9.00±0.50
10"reel for 12mm tape	Φ254.0±2.00	Φ100.0±1.00	13.0±0.20	14.0±0.20
13"reel for 8mm tape	Φ330.0±2.00	Φ100.0±1.00	13.0±0.20	9.00±0.50

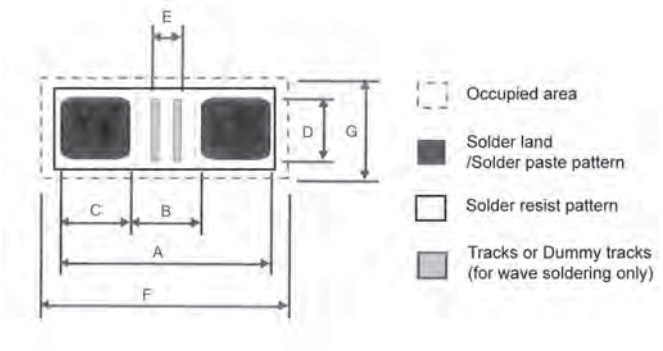
Paper Tape Specifications for WR,WF,WW Series and WA,WT Series

Unit: mm

Component Size / Series	Q'ty per reel	Reel Diameter
0603, 0805, 1206	1,000 pcs	4" reel
1210, 1206, 0805, 0603, WA06X, WA06T, WT04X	5,000 pcs	7" reel
0402, WA04X, WA04Y, WA04P, WA04T, WA04U	10,000 pcs	7" reel
0201, 0402	15,000 pcs	7" reel
WA06X, WA06Y	5,000 pcs	7" reel
2512, 2010	4,000 pcs	7" reel
1218	3,000 pcs	10" reel
1206, 0805, 0603, WA06X, WA06T	10,000 pcs	10" reel
0402, WA04X, WA04Y	20,000 pcs	10" reel
2010, 2512	8,000 pcs	10" reel
0402	70,000 pcs	13" reel
WA04X, WA04Y	40,000 pcs	13" reel
1206, 0805, 0603, WA06X,	20,000 pcs	13" reel
2010, 2512	16,000 pcs	13" reel

Footprint Design

Footprint Design for WRxx, WFxx, WWxx Series :



Unit: mm

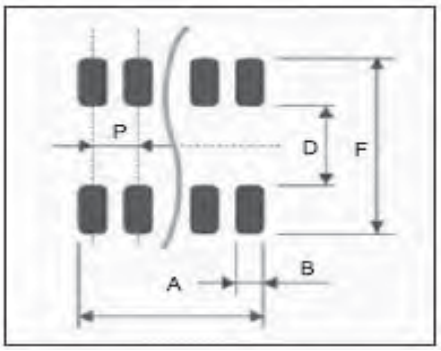
Size	Reflow Soldering							Processing Remarks	Placement Accuracy
	A	B	C	D	E	F	G		
01005	0.58	0.18	0.20	0.20	0.10	0.90	0.40	IR or hot plate soldering	±0.03
0201	0.75	0.30	0.30	0.30	0.20	1.10	0.50		±0.05
0402	1.50	0.50	0.50	0.60	0.10	1.90	1.00		±0.15
0603	2.10	0.90	0.60	0.90	0.50	2.35	1.45		±0.25
0805	2.60	1.20	0.70	1.30	0.75	2.85	1.90		±0.25
1206	3.80	2.00	0.90	1.60	1.60	4.05	2.25		±0.25
1210	3.80	2.00	0.90	2.80	1.60	4.05	3.15		±0.25
1218	3.80	2.00	0.90	4.80	1.40	4.20	5.50		±0.25
2010	5.60	3.80	0.90	2.80	3.40	5.85	3.15		±0.25
2512	7.00	3.80	1.60	3.50	3.40	7.25	3.85		±0.25

Size	Wave Soldering							Processing Number & Dimensions of dummy tracks	Placement Accuracy
	A	B	C	D	E	F	G		
0603	2.70	0.90	0.90	0.80	0.15	3.40	1.90	1× (0.15 × 0.80)	±0.25
0805	3.40	1.30	1.05	1.30	0.20	4.30	2.70	1× (0.20 × 1.30)	±0.25
1206	4.80	2.30	1.25	1.70	1.25	5.90	3.20	3× (0.2 5× 1.70)	±0.25
1210	4.80	2.30	1.25	2.50	1.25	5.90	3.60	3× (0.25 × 1.70)	±0.25
1218	4.80	2.30	1.25	4.80	1.30	5.90	5.60	3× (0.25 × 4.80)	±0.25
2010	6.30	3.50	1.40	2.50	3.00	7.00	3.60	3× (0.75 × 2.50)	±0.25
2512	8.50	4.50	2.00	3.20	3.00	9.00	4.30	3× (1.00 × 3.20)	±0.25

Footprint Design for Array Resistor/Attenuator :

Unit: mm

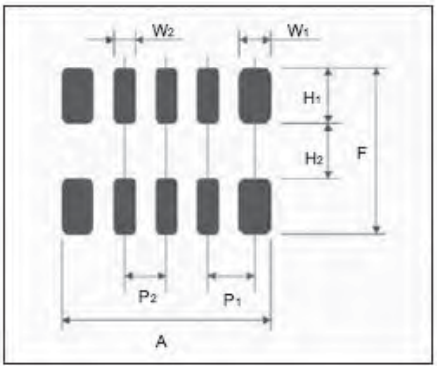
Symbol	0603*4 array	0402*4 array	WA04Y, WA04P	WA06W	WA02Y
A	2.85+0.10/-0.05	1.80+0.15/ -0.05	1.20±0.05	3.85+0.20/ -0.05	1.00±0.05
B	0.45±0.05	0.30±0.05	0.40 +0/ -0.05	0.28 +0/ -0.05	0.40 +0/ -0.05
D	0.80±0.10	0.50±0.10	0.50±0.05	1.00 +0.1/ -0.20	0.30±0.05
P	0.8	0.5	0.65	0.5	0.5
F	3.10±0.30	2.00+0.40/ -0.20	1.5 +0.20/ -0.10	3.20±0.40	1.00±0.10



Footprint Design for 10P8R Network Resistor :

Unit: mm

Symbol	WT04X
W1	0.50±0.05
W2	0.35±0.05
H2	0.80±0.10
P1	0.70±0.05
P2	0.65±0.05
A	3.20±0.10
F	2.80 + 0.40 / -0.20



Storage and Handling Conditions:

1. Products are recommended to be used up within one year. Check solders ability in case shelf life extension is needed.
2. To store products with following condition:
   Temperature :5 to 40℃
   Humidity : 20 to 70% relative humidity
3. Caution:
   a. Don't store products in a corrosive environment such as sulfide, chloride gas, or acid. It may cause oxidization of electrode, which easily be resulted in poor soldering
   b. To store products on the shelf and avoid exposure to moisture.
   c. Don't expose products to excessive shock, vibration, direct sunlight and so on

Precaution of Soldering

1. It is recommended to use a mildly activated rosin flux (less than 0.1% wt chlorine)
2. Excessive flux must be avoided
3. When water-soluble flux is used, enough washing is necessary
4. Two times limitations for reflow soldering is highly recommended
5. Solder repair by soldering iron
   a. Max. 350℃ for below 3 seconds is highly recommended
   b. Do not directly contact termination to avoid thermal shock.
6. Prevent any external force on the products until solder is cooled

Mounting

1. Imperfect adjustment of mounting machine may cause the cracks, the chipping and the alignment error. Check and inspect the mounting machine in advance.
2. Set the backup pins in proper layout otherwise the components mounted on the backside of the board are damaged. Do not set these pins at the position of the nozzle.
3. Adjust the bottom dead point of dispenser away from the board when you apply adhesive.
4. Confirm that the products are corresponding to flow soldering when you perform it.
5. Pay attention to the amount of solder because improper amount of solder place large stress on the products and cause cracks or malfunctions.

Recommendation of Soldering Profiles:

In general application, the lead free (Pb-free) termination CRs are used and may be mounted on PCB by IR reflow or wave soldering process with lead-free solder material. The recommended soldering profiles are shown as Fig.1 & 2.
The lead-free termination CRs are also suitable on SMT process against lead-containing solder paste. But the soldering temperature should be higher than the melting point of solder paste 30℃ at least.
If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N2 within oven are recommended. Advised IR reflow soldering profile is shown as Fig.3.

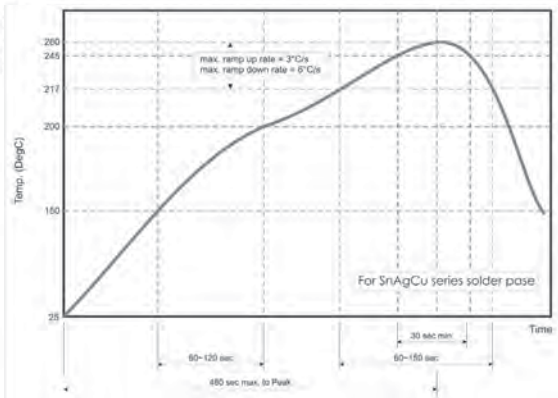


Fig. 1 Recommended IR reflow soldering profile for SMT process with SnAgCu series solder paste.

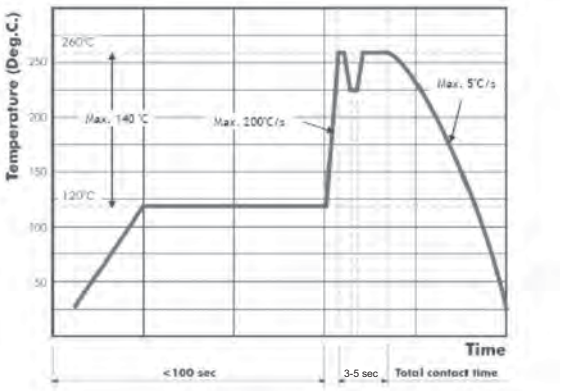


Fig. 2 Recommended wave soldering profile for SMT process with SnAgCu series solder.

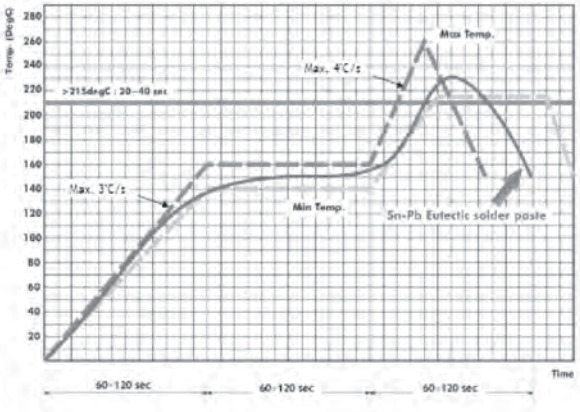


Fig. 3 Recommended reflow soldering profile for SMT process with eutectic Snpb solder paste.

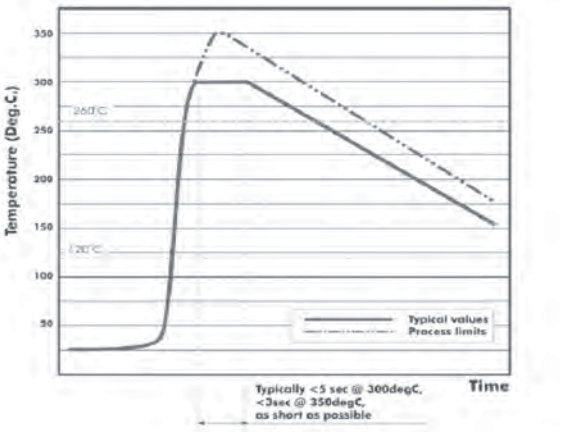


Fig. 4 Recommended soldering profile by manual with SnAgCu series solder.

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